



OGOVA

VGA product brief



OMNIVISION Expands Industry's Smallest BSI Global Shutter Pixel Family with VGA Image Sensor

OMNIVISION's OGOVA is a low voltage, high performance image sensor with the industry's smallest pixel size of 2.2 microns. The OGOVA features OMNIVISION's PureCel®Plus-S stacked pixel architecture and Nixel® NIR technology to enable optimal performance and precision along with industry-leading QE and excellent MTF for sharp, accurate images in machine vision and 3D sensing applications. This image sensor is an expansion of its backside-illuminated (BSI), global shutter (GS) sensor family that provides VGA resolution options with the best NIR performance in a global shutter device.

The OGOVA image sensor provides 640 x 480 VGA resolution at 240 frames per second (fps) and 320 x 240 QVGA resolution at 480 fps, in the industry's smallest optical format of 1/10 inches. Additionally, its low light sensitivity is excellent, with significantly lower gain than the industry's typical 3.0 micron pixel size for an improved signal-to-noise ratio.

The image sensor's high MTF enables sharper images with greater contrast and more detail, which helps to enhance machine vision decision-making processes. The OGOVA also has a high QE of 40% at 940 nm and 60% at 850 nm. This industry-leading QE enables the device to see farther and better in low- and no-light conditions, which allows designers to use less IR LED light and achieve lower system-level power consumption. For AR/VR headsets, this reduces heat generation, while industrial and robotics applications can use fewer IR LEDs for lower system cost, or use the same number to achieve a greater image detection range.

Find out more at www.ovt.com.



- OGOVA1B-A25A (b&w, lead free, 25-pin CSP)
- OGOVA1B-GA5A (b&w, chip probing, 150 μm backgrinding, reconstructed wafer with good die)

Applications

- machine vision
- industrial automation
- augmented and virtual reality
- gaming
- biometric authentication
- drones
- 3D imaging
- industrial bar code scanning

Technical Specifications

- **active array size:** 640 x 480
- **maximum image transfer rate:**
 - VGA (640x480): 240 fps
 - QVGA (320x240): 480 fps
- **power supply:**
 - analog: 2.8V (nominal)
 - core: 1.2V (nominal)
 - I/O: 1.8V (nominal)
- **power requirements:**
 - active: 123 mW
 - XSHUTDOWN: 10 μA
- **lens size:** 1/10"
- **temperature range:**
 - operating: -30°C to +85°C junction temperature
 - stable image: 0°C to +60°C junction temperature
- **lens chief ray angle:** 23.4° non-linear
- **output interfaces:** 1-lane MIPI / LVDS serial output
- **output formats:** 10-bit RAW
- **pixel size:** 2.2 μm x 2.2 μm
- **image area:** 1443.2 μm x 1091.2 μm

Product Features

- 2.2 μm x 2.2 μm pixel with PureCel®Plus-S, Global Shutter, and Nyxel® technologies
- automatic black level calibration (ABLC)
- programmable controls for:
 - frame rate
 - mirror and flip
 - cropping
- support output formats: 10-bit RAW
- fast mode switching
- supports horizontal and vertical 2:1 subsampling
- supports 2x2 binning
- 1-lane MIPI/LVDS serial output interface
- support for image sizes:
 - 640 x 480
 - 320 x 240
- embedded 128 bytes of one-time programmable (OTP) memory for part identification
- two on-chip phase lock loops (PLLs)
- built-in strobe control
- support for multi-sensor mode operation

Functional Block Diagram

